# R Series Intelligent DAQ — Data Acquisition and Control with Onboard Processing

## NI 781xR, NI 783xR, NI PXI-784xR, NI PXI-785xR *NEW!*

- Onboard FPGA chip, programmable with the LabVIEW FPGA Module
- User-defined triggering, timing, and decision making in hardware with 25 ns resolution
- Up to 8 analog inputs, independent sampling rates up to 750 kHz, 16-bit resolution
- Up to 8 analog outputs, independent update rates up to 1 MHz, 16-bit resolution
- Up to 160 digital lines configurable as inputs, outputs, counters, or custom logic at rates up to 40 MHz
- Direct memory access (DMA) channels for high-speed data streaming
- Implement custom control logic, inline signal processing, and digital communication protocols

## **Operating Systems**

- Windows XP/2000
- LabVIEW Real-Time

#### **Recommended Software**

- LabVIEW
- LabVIEW FPGA Module
  - LabVIEW code compiler for FPGAs
  - Emulated debugging mode
- LabVIEW Real-Time Module

#### **Driver Software (included)**

• NI-RIO



#### **Calibration Certificate Available**

Product	Bus/Form Factor	FPGA	Analog Inputs (16-Bit)	Max Sampling Rate per Channel (kS/s)	Analog Outputs (16-Bit)	Max Update Rate per Channel (MS/s)	Digital I/O
Multifunction R Series	3						
NI 7851R	PXI	Virtex-5 LX30	8	750	8	1	96
NI 7852R	PXI	Virtex-5 LX50	8	750	8	1	96
NI 7853R	PXI	Virtex-5 LX85	8	750	8	1	96
NI 7854R	PXI	Virtex-5 LX110	8	750	8	1	96
NI 7841R	PXI	Virtex-5 LX30	8	200	8	1	96
NI 7842R	PXI	Virtex-5 LX50	8	200	8	1	96
NI 7830R	PCI, PXI	Virtex-II 1M gates	4	200	4	1	56
NI 7831R	PCI, PXI	Virtex-II 1M gates	8	200	8	1	96
NI 7833R	PCI, PXI	Virtex-II 3M gates	8	200	8	1	96
Digital R Series							
NI 7811R	PCI, PXI	Virtex-II 1M gates	-	_	_	_	160
NI 7813R	PCI, PXI	Virtex-II 3M gates	-	-	-	-	160

Table 1. R Series Selection Guide

#### **Overview**

Intelligent DAQ is multifunction data acquisition that features user-defined onboard processing as well as complete flexibility of I/O timing and triggering. You can configure all device functionality by creating NI LabVIEW block diagrams with the LabVIEW FPGA Module. Your block diagram executes in hardware, giving you direct, immediate control of all I/O signals on the PXI or PCI device. With R Series and LabVIEW FPGA, you can configure user-defined hardware for a wide variety of applications requiring precise timing and control such as:

- Data acquisition with flexible triggering and onboard processing
- High-speed analog and discrete control loops
- · Pulse-width modulation (PWM) and encoder interfacing
- User-defined digital communication protocols
- Custom counters with up to 64-bit resolution
- · Hardware-timed decision making at 40 MHz

## **Kev Features**

Through programming in LabVIEW FPGA, you can control each of the I/O signal lines independently or synchronize a line with other channels. You can configure the digital I/O lines as custom counter/timers, PWM channels, or communication buses for user-defined protocols. All multifunction R Series devices have dedicated analog-to-digital converters/digital-to-analog converters on every analog I/O channel. This offers specialized functionality such as multirate sampling and individual channel triggering, which are beyond the capabilities of typical data acquisition hardware. You can sample every analog input channel on an R Series device simultaneously at rates up to 750 kHz, and you can program every analog output on an R Series device to update simultaneously at rates up to 1 MHz. You can also store your compiled LabVIEW FPGA application in the onboard flash memory of any R Series device and configure it for automatic loading and/or execution at power up.



## **New Virtex-5 FPGAs**

The new NI PXI-784xR and PXI-785xR modules use new Virtex-5 field-programmable gate arrays (FPGAs) with improved optimization capabilities that provide faster code execution and increased code capacity. These Virtex-5 FPGAs feature a new six-input lookup table (LUT) architecture for substantially improved resource utilization as well as DSP48 slices that make it possible for you to implement more complex digital signal processing at faster rates. Previous-generation Virtex-II FPGAs use four-input LUTs for up to 16 combinations of digital logic values. The new Virtex-5 FPGAs use six-input LUTs for up to 64 combinations, increasing the amount of logic that you can implement per slice. In addition, the slices themselves are placed in closer proximity to each other to reduce the propagation delay of electrons and increase overall execution rates. The single-cycle timed loop structure in LabVIEW FPGA takes full advantage of six-input LUTs for substantially improved resource utilization. This means you can optimize more LabVIEW FPGA code to fit within Virtex-5 FPGAs and perform more operations per clock cycle.

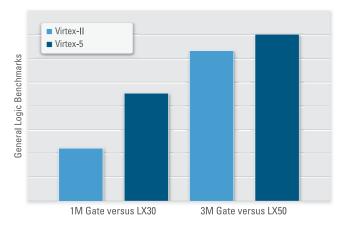


Figure 1. General logic benchmarks show that Virtex-5 FPGAs offer larger sizes when compared to Virtex-II FPGAs.

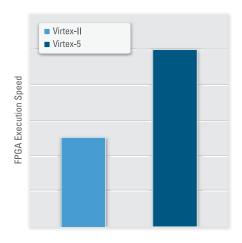


Figure 2. Execution speed benchmarks show that Virtex-5 FPGAs feature faster processing capabilities when compared to Virtex-II FPGAs.

For more information on LabVIEW FPGA benchmarks for Virtex-5 FPGAs, visit ni.com/info and enter lvfpgabenchmarks.

## **Recommended Accessories**

## **High Performance**

**SHC68-68-RMIO** – High-performance shielded 68-conductor cable terminated with a VHDCI 68-pin male connector at one end and a 68-pin female 0.050 D-type connector at the other end that has been specifically designed for the multifunction I/O connector on R Series intelligent DAQ devices.

1 m	 189588-01
2 m	 189588-02

**SHC68-68-RD10** — High-performance shielded 68-conductor cable terminated with a VHDCI 68-pin male connector at one end and a 68-pin female 0.050 D-type connector at the other end that has been specifically designed for the digital I/O connector on R Series intelligent DAQ devices.

1 m .....191667-01

**SCB-68** – Shielded I/O connector block for rugged, very low-noise signal termination for connecting to 68-pin devices. The SCB-68 also includes two general-purpose breadboard areas.

Dimensions - 19.5 by 15.2 by 4.5 cm (7.7 by 6.0 by 1.8 in.)

## **Low Cost**

**SH68-C68-S** – General-purpose shielded cable that connects any type of R Series connector to 68-pin connector blocks.

$0.5  \mathrm{m}$	1	186381-0R5
1 m		186381-01
2 m		186381-02

#### **Custom Cabling**

**SHC68-NT-S** — Shielded 68-conductor cable terminated with a 68-pin male VHDCl connector at one end and unterminated bare wires at the other. Use this cable, ideal for OEM applications, to create custom cabling solutions for R Series devices.

**NSC68-262650** – Shielded cable terminated with a VHDCI 68-pin male connector at one end and two 26-pin ribbon connectors and one 50-pin ribbon connector on the other; designed to connect the R Series RMIO connector to standard ribbon cable accessories.

1 m ......189151-01

**NSC68-5050** — Shielded cable terminated with a VHDCI 68-pin male connector at one end and two 50-pin ribbon connectors on the other; designed to connect R Series RDIO connectors to standard ribbon cable accessories.

1 m ......189152-01

## Required Software for R Series Intelligent DAQ

- NI 781xR and 783xR devices require the LabVIEW FPGA Module 7.1 or later and NI-RIO 1.3 or later driver software.
- NI 784xR and 785xR devices require the LabVIEW FPGA Module 8.5.1 or later and NI-RIO 2.4 or later.
- NI 7853R and 7854R devices require the LabVIEW FPGA Module 8.6 or later and NI-RIO 3.0 or later.

## **Low-Cost Signal Conditioning and Channel Expansion**

The NI cRIO-9151 R Series expansion chassis connects directly to any digital connector on R Series devices and houses up to four C Series I/O modules for industrial signal conditioning, I/O channel expansion, and direct sensor connectivity.

## **Ordering Information**

PCI	
NI PCI-7811R	779363-01
NI PCI-7813R	779370-01
NI PCI-7830R	779361-01
NI PCI-7831R	778797-01

NI PCI-7833R......779359-01

#### PXI

NI PXI-7811R	778800-01
NI PXI-7813R	779362-01
NI PXI-7830R	779364-01
NI PXI-7831R	778668-01
NI PXI-7833R	779360-01
NI PXI-7841R	780337-01
NI PXI-7842R	780338-01
NI PXI-7851R	780339-01
NI PXI-7852R	780340-01
NI PXI-7853R	780341-01
NI PXI-7854R	780342-01

## **BUY NOW!**

Includes NI-RIO driver software

For complete product specifications, pricing, and accessory information, call 800 813 3693 (U.S.) or go to ni.com/rseries.

## **Specifications**

## Analog Input (NI 783xR/784xR/785xR Only)

## **Input Characteristics**

Number of channels	
NI 7830R	4
NI 7831R/7833R/784xR/785xR	8
Input modes	DIFF, RSE, NRSE
	(software-selectable; selection
	applies to all channels)
Type of ADC	Successive approximation
Resolution	16 bits, 1 in 65,536
Conversion time	
NI 783xR/NI 784xR	4 μs
NI 785xR	1 μs
Maximum sampling rate	
NI 783xR/NI 784xR	200 kS/s (per channel)
NI 785xR	750 kS/s (per channel)
Input impedance	
Powered on	10 $ extsf{G}\Omega$ in parallel with 100 pF
Powered off/overload	$4.0 \text{ k}\Omega$ min
Input signal range	±10 V
Input bias current	
NI 783xR	±2 nA
NI 784xR/785xR	±5 nA
Input offset current	
NI 783xR	±1 nA
NI 784xR/785xR	±5 nA
Input coupling	DC
Maximum working voltage	
(signal + common mode)	Inputs should remain
	within ±12 V of ground
Overvoltage protection	
Powered on	±42 V
Powered off	±35 V
Data transfers	DMA, interrupts, programmed I/O

## Accuracy Information – NI 783xR

Nominal Range (V		% of R	oodina		No	Accuracy pise + prization		Absolute Accuracy		Accuracy
Positive Full Scale	Negative Full	24	<b>J</b>	Offset	Sinale		Temp Drift (%/°C)	at Full Scale	Single Point	Averaged
10.0	-10.0	0.0496	0.0507	2.542	1779	165	0.0005	7.78	2.170	217

Note: Accuracies are valid for measurements following an internal calibration. Averaged numbers assume dithering and averaging of 100 single-channel readings. Measurement accuracies are listed for operational temperatures within ±1 °C of internal calibration temperature and ±10 °C of external or factory-calibration temperature.

## Accuracy Information - NI 784xR/785xR

					Absolute Accuracy				Relative Accuracy		
Nominal Range (V)		% of Reading		Noise + Quantization			Absolute Accuracy		ion (μV)		
Positive Full Scale	Full	24	1 Year	Offset (µV)	Single Point	Averaged	Temp Drift (%/°C)	at Full Scale (±mV)	Single Point	Averaged	
10.0	-10.0	0.0186	0.0228	1.591	1.029	91.6	0.0005	3.97	1.205	121	

Note: Accuracies are valid for measurements following an internal calibration. Averaged numbers assume dithering and averaging of 100 single-channel readings. Measurement accuracies are listed for operational temperatures within ±1 °C of internal calibration temperature and ±10 °C of external or factory-calibration temperature.

## **DC Transfer Characteristics**

INL	
NI 783xR	±3 LSB typ, ±6 LSB max
NI 784xR/785xR	±1 LSB typ, ±3 LSB max
DNL	
NI 783xR	-1.0 to +2.0 LSB max
NI 784xR/785xR	±0.4 LSB typ, ±0.9 LSB max
No missing codes	
NI 783xR	16 bits typ, 15 bits min
NI 784xR/785xR	16 bits guaranteed
CMRR, DC to 60 Hz	-86 dB

## **Settling Time**

			Accuracy	
Device	Step Size	16 LSB	4 LSB	2 LSB
NI 783xR	±20.0 V	7.5 µs	10.3 μs	40 μs
INI 783XH	±2.0 V	2.7 µs	4.1 µs	5.1 µs
	±0.2 V	1.7 µs	2.9 µs	3.6 µs
NII 704 D/	±20.0 V	2.1 µs	4.2 µs	8 µs
NI 784xR/ 785xR	±2.0 V	1.3 µs	1.6 µs	1.8 µs
703811	±0.2 V	0.8 μs	1.1 µs	1.2 µs

Crosstalk.....-80 dB, DC to 100 kHz

## **Dynamic Characteristics**

## Analog Output (NI 783xR/784xR/785xR Only)

## **Output Characteristics**

Number of channels	
NI 7830R	4
NI 7831R/7833R/784xR/785xR	8
Output type	Single-ended, voltage output
Resolution	16 bits, 1 in 65,536
Update time	1.0 μs
Maximum update rate	1 MS/s
Type of DAC	Enhanced R-2R
Data transfers	DMA, interrupts,
	programmed I/O

## R Series Intelligent DAQ -**Data Acquisition and Control with Onboard Processing**

	-							
Voltage	. Outpu	t					Protection	
_	-			+10 V			Input	
Range 5 Output coupling [						NI 781xR/783xR	. 3	
Output impedance			20			NI 784xR/785xR	-20.0 to 20.0 V, single line	
				$1.25 \Omega$			Output	
								may be shorted at a time)
Current dr							Minimum pulse width	
Protection					cuit to gr	ound	Input	
Power-on	state			User cor	nfigurable		Output	
Accura	cy Info	rmatior	1				Minimum sampling period	5 ns
	•		Absolute A	ccuracy			Reconfigurable FPGA	
Nominal Ra	ange (V)	% of Re				Absolute	NI 7811R/7830R/7831R	
Positive	Negative	04.11	4 V	Offset (µv)	Temp Drift (%/°C)	Accuracy at Full Scale (mV)	FPGA type	Virtex-II 1000
Full Scale		24 Hours	1 Year				Number of flip-flops	10,240
Note: Accurac	-10.0	0.0335 or analog outpu	0.0351	2,366 n internal calibra	0.0005	5.88 utput accuracies are	Number of 4-input LUTs	
listed for oper	ration temperat	tures within ±1	°C of interna	I calibration tem	perature and ±	10 °C of external or 1 ±10 °C of previous	Number of 18x18 multipliers	
external calib		ure. remperatur	е ипт аррпе:	s unity it ambient	is greater trial	1±10 C of previous	Embedded block RAM	720 kb
DC Trar	nsfer Cl	haracte	rietics	•			NI 7813R/7833R	
					) + 10 110	NICD may	FPGA type	Virtex-II 3000
						LSB max	Number of flip-flops	
				±0.5 LSB typ, ±1 LSB max 16 bits, guaranteed			Number of 4-input LUTs	28,672
	•			io bits,	guarantoc	,u	Number of 18x18 multipliers	
Settling	y Time						Embedded block RAM	1,728 kb
Step S	Size	16 LSI	В	Accurac 4 LSB	y	2 LSB	NI 7841R/7851R	
±20.0		6.0 µs		6.2 µs		7.2 µs	FPGA type	Virtex-5 LX30
±2.0	V	2.2 µs	S	2.9 µs		3.8 µs	Number of flip-flops	
±0.2	V	1.5 µs	3	2.6 µs		3.6 µs	Number of 6-input LUTs	19,200
Dynami	ic Char	acteris	tics				Number of DSP48	
Slew rate				10 V/µs			slices (25x18 multipliers)	32
				150 μV <sub>rn</sub>	DC to 1	I MHz	Embedded block RAM	1,152 kb
				±200 m\		I IVII IZ	NI 7842R/7852R	
Digital	I/O						FPGA type	Virtex-5 LX50
_		•					Number of flip-flops	
Number of channels NI 7811R/7813R			160			Number of 6-input LUTs	28,800	
				56			Number of DSP48	
						slices (25x18 multipliers)	48	
Digital log					5 \/ TTI	. Compatible	Embedded block RAM	1,728 kb
Digital 109					L, J V IIL	·	NI 7853R	
le le	Level nput low volt			Min (V) 0.0 V		<b>Max (V)</b> 0.8 V	FPGA type	Virtex-5 LX85
	iput iow voit iput high volt			0.0 V 2.0 V		0.8 V 5.5 V	Number of flip-flops	51,840
	tput low volt	0 1 1117				0.4 V	Number of 6-input LUTs	51,840
	where I <sub>OUT</sub> =	-4 mA					Number of DSP48	01,070

3.3 V

Programmable, by line

DMA, interrupts,

programmed I/O

Output high voltage (V<sub>OH</sub>),

where  $I_{OUT} = 4 \text{ mA}$ 

Power-on state.....

Data transfers .....

Source 4.0 mA Sink ...... 4.0 mA Input leakage current..... ±10 µA

Output current

Output	Short-circuit (up to eight lines may be shorted at a time)
Minimum pulse width Input Output Minimum sampling period	25 ns 12.5 ns
Reconfigurable FPGA	
NI 7811R/7830R/7831R	
FPGA type  Number of flip-flops  Number of 4-input LUTs  Number of 18x18 multipliers  Embedded block RAM	Virtex-II 1000 10,240 10,240 40 720 kb
NI 7813R/7833R	
FPGA type  Number of flip-flops  Number of 4-input LUTs  Number of 18x18 multipliers  Embedded block RAM	Virtex-II 3000 28,672 28,672 96 1,728 kb
NI 7841R/7851R	
FPGA typeNumber of flip-flopsNumber of 6-input LUTsNumber of DSP48	Virtex-5 LX30 19,200 19,200
slices (25x18 multipliers) Embedded block RAM	32 1,152 kb
NI 7842R/7852R	
FPGA type Number of flip-flops Number of 6-input LUTs Number of DSP48 slices (25x18 multipliers) Embedded block RAM	Virtex-5 LX50 28,800 28,800 48 1,728 kb
NI 7853R	
FPGA type  Number of flip-flops  Number of 6-input LUTs  Number of DSP48  slices (25x18 multipliers)  Embedded block RAM	Virtex-5 LX85 51,840 51,840 48 3,456 kb
NI 7854R	
FPGA type  Number of flip-flops  Number of 6-input LUTs  Number of DSP48  slices (25x18 multipliers)	Virtex-5 LX110 69,120 69,120
Embedded block RAM	4,608 kb
	0.411 000 040 0000 (11.0.)

## R Series Intelligent DAQ – Data Acquisition and Control with Onboard Processing

Timebases	
Timebase reference sources	
NI PCI-781xR/783xR	Onboard clock only
NI PXI-78xxR	Onboard clock, phase-locked to
	PXI 10 MHz clock
LabVIEW FPGA derived clocks	Up to 200 MHz
Timebase accuracy, onboard clock	±100 ppm, 250 ps
	peak-to-peak jitter
Phase-locked to PXI 10 MHz clock	A 11 050
(NI PXI-78xxR only)	
Additional frequency-dependent peak-t	o-peak jitter
NI 781xR/783xR 40 MHz	None
80 MHz	400 ps
120 MHz	720 ps
160 MHz	710 ps
200 MHz	700 ps
NI 784xR/785xR	·
40 MHz	None
80 MHz	460 ps
120 MHz	172 ps
Calibration (NI 783xR/784xR/	/785xR Only)
Recommended warm-up time	15 minutes
Calibration interval	1 year
Onboard calibration reference	
DC level	5.000 V (±3.5 mV) (actual value
Townson townson of the install	stored in flash memory)
Temperature coefficient Long-term stability	±5 ppm/°C max ±20 ppm/1,000 h
,	
Note: Refer to Calibration Certificates	
generate a calibration certificate for the	e INI 783XK.
Bus Interface	
PXI (NI PXI-78xxR only)	Master, slave
PCI (NI PCI-781xR/783xR only)	Master, slave
Physical	
Dimensions (not including connectors)	
	17 by 11 cm (6.7 by 4.3 in.)
NI PXI-78xxR	16 by 10 cm (6.3 by 3.9 in.)
Weight	440
NI PCI-781xR/783xR	112 g
NI PXI-78xxRI/O connectors	152 g
NI 781xR	Four 68-pin female
11 / O I AIT	high-density VHDCI type
NU 700 D (704 D (705 D	TI 00 : ( )

NI 783xR/784xR/785xR .....

Three 68-pin female high-density VHDCI type

## **Maximum Working Voltage**

Maximum working voltage refers to the signal voltage plus the common-mode voltage.

**Caution:** Do not use the NI 783xR/784xR/785xR for connection to signals in Measurement Category II, III, or IV.

## **Power Requirement**

+5 VDC (±5%) <sup>1</sup>	
NI 781xR	9 mA (typ), 50 mA (max)
NI 7830R/7831R	330 mA (typ), 355 mA (max)
NI 7833R	364 mA (typ), 586 mA (max)
NI 7841R/7851R	125 mA (typ), 252 mA (max)
NI 7842R/7852R	136 mA (typ), 291 mA (max)
NI 7853R	460 mA typ
NI 7854R	484 mA typ
+3.3 VDC (±5%) <sup>2</sup>	
NI 7811R	650 mA (typ), 1,000 mA (max)
NI 7813R	850 mA (typ), 1,350 mA (max)
NI 7830R/7831R	462 mA (typ), 660 mA (max)
NI 7833R	727 mA (typ), 1,148 mA (max)
NI 7841R/7851R	525 mA (typ), 1,244 mA (max)
NI 7842R/7852R	604 mA (typ), 1,484 mA (max)
NI 7853R	640 mA typ
NI 7854R	843 mA typ
+12 V	
NI 784xR/785xR	0.5 A
-12 V	
NI 784xR/785xR	0.25 A
+5 V terminal	
Connector 0	0.5 A max
Connector 1	
Connector 2	0.5 A max
All connectors	1.5 A max <sup>3</sup>
To calculate the total current sourced h	ny the digital outputs use

To calculate the total current sourced by the digital outputs, use the following equation:

 $\sum_{i=1}^{\sqrt{j}} \quad \text{current sourced on channel i}$ 

Power available at I/O connectors ..... 4.50 to 5.25 VDC at 1 A total, 250 mA per I/O connector pin

<sup>&</sup>lt;sup>1</sup> Does not include current drawn from the +5 V line on the I/O connectors.

<sup>&</sup>lt;sup>2</sup> Does not include current sourced by the digital outputs.

<sup>&</sup>lt;sup>3</sup> The NI 784xR/785xR devices have a user-replaceable socketed fuse that opens when current exceeds the current specification. Refer to the R Series Intelligent DAQ User Manual, available at ni.com/manuals, for information about fuse replacement.

## R Series Intelligent DAQ – **Data Acquisition and Control with Onboard Processing**

#### **Environmental**

NI 78xxR devices are intended for indoor use only.

## **Operating Environment**

0 to 55 °C (tested in
accordance with IEC-60068-2-1
and IEC-60068-2-2)
and 120 00000 2 2,
0 to 55 °C (tested in
accordance with IEC-60068-2-1
and IEC-60068-2-2)
7853R/7854R
0 to 55 °C (tested in
accordance with IEC-60068-2-1
and IEC-60068-2-2)
0 to 55 °C except the
following: 0 to 45 °C when
installed in an NI PXI-1000/B or
NI PXI-101x (tested in
accordance with IEC-60068-2-1
and IEC-60068-2-2)
10 to 90%, noncondensing
(tested in accordance with
IEC-60068-2-56)
2,000 m at 25 °C
ambient temperature
ambient temperature
-20 to 70 °C (tested in

Note: Clean the device with a soft, nonmetallic brush. Make sure that the device is completely dry and free from contaminants before returning it to service.

accordance with IEC-60068-2-1

and IEC-60068-2-2)

IEC-60068-2-56)

5 to 95%, noncondensing

(tested in accordance with

## **Shock and Vibration (for NI PXI-78xxR Only)**

Relative humidity range.....

Operational shock	30 g peak, half-sine, 11 ms pulse (tested in accordance with IEC-60068-2-27; test profile developed in accordance with MIL-PRF-28800F)
Random vibration	
Operating Nonoperating	5 to 500 Hz, 0.3 g <sub>rms</sub> 5 to 500 Hz, 2.4 g <sub>rms</sub> (tested in accordance with IEC-60068-2-64; nonoperating test profile exceeds the requirements of MIL-PRF-28800F, Class 3)

#### Safety and Compliance

NI 78xxR devices are designed to meet the requirements of the following standards of safety for electrical equipment for measurement, control, and laboratory use:

- IEC 61010-1, EN 61010-1
- UL 61010-1, CSA 61010-1

Note: For UL and other safety certifications, refer to the product label or visit **ni.com/certification**, search by model number or product line, and click the appropriate link in the Certification column.

## **Electromagnetic Compatibility**

This product meets the requirements of the following EMC standards for electrical equipment for measurement, control, and laboratory use:

- EN 61326 (IEC 61326): Class A emissions; Basic immunity
- EN 55011 (CISPR 11): Group 1, Class A emissions
- AS/NZS CISPR 11: Group 1, Class A emissions
- FCC 47 CFR Part 15B: Class A emissions
- ICES-001: Class A emissions

#### **CE Compliance**

This product meets the essential requirements of applicable European Directives, as amended for CE marking, as follows:

- 2006/95/EC: Low-Voltage Directive (safety)
- 2004/108/EC; Electromagnetic Compatibility Directive (EMC)

**Note:** Refer to the Declaration of Conformity (DoC) for this product for any additional regulatory compliance information. To obtain the DoC for this product, visit ni.com/certification, search by model number or product line, and click the appropriate link in the Certification column.

## **Environmental Management**

National Instruments is committed to designing and manufacturing products in an environmentally responsible manner. NI recognizes that eliminating certain hazardous substances from our products is beneficial not only to the environment but also to NI customers.

For additional environmental information, refer to the NI and the Environment Web page at **ni.com/environment**. This page contains the environmental regulations and directives with which NI complies, as well as other environmental information not included in this document.

#### **Waste Electrical and Electronic Equipment (WEEE)**

EU Customers: At the end of their life cycle, all products must be sent to a WEEE recycling center. For more information about WEEE recycling centers and National Instruments WEEE initiatives, visit ni.com/environment/weee.htm.

#### 电子信息产品污染控制管理办法(中国 RoHS)



● 中国客户 National Instruments 符合中国电子信息产品中限制使用某些有害物质指 令 (RoHS)。关于 National Instruments 中国 RoHS 合规性信息,请登录 ni.com/environment/rohs\_china. (For information about China RoHS compliance, go to ni.com/environment/rohs\_china.)

## **NI Services and Support**



NI has the services and support to meet your needs around the globe and through the application life cycle — from planning and development through deployment and ongoing maintenance. We offer services and service levels to meet customer requirements in research, design, validation, and manufacturing. Visit ni.com/services.

## **Training and Certification**

NI training is the fastest, most certain route to productivity with our products. NI training can shorten your learning curve, save development time, and reduce maintenance costs over the application life cycle. We schedule instructor-led courses in cities worldwide, or we can hold a course at your facility. We also offer a professional certification program that identifies individuals who have high levels of skill and knowledge on using NI products. Visit ni.com/training.

## **Professional Services**

Our NI Professional Services team is composed of NI applications and systems engineers and a worldwide National Instruments Alliance Partner program of more than 600 independent consultants and



integrators. Services range from start-up assistance to turnkey system integration. Visit **ni.com/alliance**.

## **OEM Support**

We offer design-in consulting and product integration assistance if you want to use our products for OEM applications. For information about special pricing and services for OEM customers, visit **ni.com/oem**.

## **Local Sales and Technical Support**

In offices worldwide, our staff is local to the country, giving you access to engineers who speak your language. NI delivers industry-leading technical support through online knowledge bases, our applications engineers, and access to 14,000 measurement and automation professionals within NI Developer Exchange forums. Find immediate answers to your questions at ni.com/support.

We also offer service programs that provide automatic upgrades to your application development environment and higher levels of technical support. Visit **ni.com/ssp**.

## **Hardware Services**

## **NI Factory Installation Services**

NI Factory Installation Services (FIS) is the fastest and easiest way to use your PXI or PXI/SCXI combination systems right out of the box. Trained NI technicians install the software and hardware and configure the system to your specifications. NI extends the standard warranty by one year on hardware components (controllers, chassis, modules) purchased with FIS. To use FIS, simply configure your system online with ni.com/pxiadvisor.

#### **Calibration Services**

NI recognizes the need to maintain properly calibrated devices for high-accuracy measurements. We provide manual calibration procedures, services to recalibrate your products, and automated calibration software specifically designed for use by metrology laboratories. Visit ni.com/calibration.

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NI provides complete repair services for our products. Express repair and advance replacement services are also available. We offer extended warranties to help you meet project life-cycle requirements. Visit **ni.com/services**.



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